

PCN# 20150302001 SPIL Taiwan Ball Placement Flux Change Notification / Sample Request

Dear Customer:

This is an announcement of a change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

We request you acknowledge receipt of this notification within **30** days of the date of this notice. Lack of acknowledgement of this notice within 30 days constitutes acceptance of the change. If you require samples or additional data to support your evaluation, please request within 30 days.

The proposed first ship date is indicated on page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager (<u>PCN ww admin team@list.ti.com</u>).

Sincerely,

PCN Team SC Business Services

PCN# 20150302001 Attachment: 1

Products Affected:

According to our records, there are the affected device(s) that you have purchased within the past twenty-four (24) months. Technical details of this Product Change follow on the next page(s).

PCN Number: 201	PCN Number: 20150302001 PCN Date: 04/22/2015								04/22/2015					
Title: DPP260x Solder Ball Flux Change														
Customer Contact:	<u>dlp</u> <u>m@t</u>	<u>ocn_tea</u> i.com	tea m Dept: DLP® CQE			ĮΕ								
Proposed 1 st Ship Date: 7/15/			015 Estimated S Avail			l Sa ila	ample 4/1/2015							
Change Type:			_											
Assembly Site			Design Wafer Bump Site					np Site						
Assembly Process			Data S	Data Sheet			Wafer Bump Material							
Assembly Materials			Part nu	Part number change			Wafer Bump Process							
Mechanical Specification			lest S	_ Test Site			Wafer Fab Site							
Packing/Shipping/Labeling		ing	lest Pi	Test Process			Water Fab Materials							
			DCN	Dotail	~		vvare	rFab	Process					
Description of Chan			PUN	Details	5									
DBD260x colder ball fl	je: uv is c	banging	1											
SPIL Taiwan is changing flux type from FW6400 to WF6317.														
Reason for Change:														
1) Improve overall ma	nufac	turability	/											
2) Better inventory ma	anagei	ment, as	wF6317	is now SF	PILs standa	ard								
Anticipated impact of	on For	m, Fit,	Function	, Quality	or Reliab	oilit	ty (pos	itive	/ negative):					
None.							5 4							
Changes to product	ident	ificatior	n resultin	a from t	his PCN:									
None				9										
Product Affected:														
Device	e			Part	Numbe	er								
DPP2601			2510464-0001											
DPP2601			2510464-0001R											
DLPC2607			2510465-0001											
DLPC2607			2510465-0001R											
DLPC300ZVB			DLPC300ZVB											
Qualification Data														
This qualification has been developed for the validation of this change. The qualification data validates that the proposed change meets the applicable released technical specifications.														
Qualification: 🗌 Plan 🖾 Test Results														
Test Criteria:														
Ball Surface – for discoloration (not allowed).														
 Flux Residue – (not allowed). Bell Sheer Test 														
 Dali Shedi Test Ball Pull Test 														

Monitor Plan:								
5 Lots Tested								
Item	Sample Size	Criteria						
Missing ball	100%/ lot	>99.5%						
Big ball	100%/ lot	>99.5%						
Ball bridge	100%/ lot	>99.5%						
Flux residue	100%/ lot	Not allow						
Ball pull/ ball shear	8 ball/ pcs/ 3pcs/ lot	> SPEC criteria						

Qualification Testing Results:

- A total of 9,984 parts were tested.
- All results passed.
- No Flux residue observed through SEM,

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
DLP PCN Team	<u>dlp_pcn_team@ti.com</u>
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com